**Power Generation** 



# Ultrahigh Power Factor in Thermoelectric System $Nb_{0.95}M_{0.05}FeSb$ (M = Hf, Zr, and Ti)

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Conversion efficiency and output power are crucial parameters for thermoelectric power generation that highly rely on figure of merit *ZT* and power factor (PF), respectively. Therefore, the synergistic optimization of electrical and thermal properties is imperative instead of optimizing just *ZT* by thermal conductivity reduction or just PF by electron transport enhancement. Here, it is demonstrated that Nb<sub>0.95</sub>Hf<sub>0.05</sub>FeSb has not only ultrahigh PF over ~100  $\mu$ W cm<sup>-1</sup> K<sup>-2</sup> at room temperature but also the highest *ZT* in a material system Nb<sub>0.95</sub>M<sub>0.05</sub>FeSb (M = Hf, Zr, Ti). It is found that Hf dopant is capable to simultaneously supply carriers for mobility optimization and introduce atomic disorder for reducing lattice thermal conductivity. As a result, Nb<sub>0.95</sub>Hf<sub>0.05</sub>FeSb distinguishes itself from other outstanding NbFeSbbased materials in both the PF and *ZT*. Additionally, a large output power density of ~21.6 W cm<sup>-2</sup> is achieved based on a single-leg device under a temperature difference of ~560 K, showing the realistic prospect of the ultrahigh PF for power generation.

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1. Introduction

Thermoelectric materials are capable to directly convert heat to electricity, providing an effective route to recover waste heat.<sup>[1–5]</sup> The conversion efficiency  $\eta$  is determined by Carnot limit and materials' property, figure of merit *ZT*, defined as  $ZT = (S^2\sigma/\kappa)T$ , where *S*,  $\sigma$ ,  $\kappa$ , and *T* are the Seebeck coefficient, the electrical conductivity, the total thermal conductivity, and the absolute temperature, respectively, and the product  $(S^2\sigma)$  is called power factor (PF).<sup>[6–8]</sup> A higher *ZT* will result in a higher  $\eta$ , therefore improvement of *ZT* has been the goal for the thermoelectric community.

One effective strategy for ZT improvement is to minimize the lattice thermal conductivity by scattering phonons off crystal defects, e.g., grain boundaries,<sup>[9–14]</sup>

dislocations,<sup>[15–18]</sup> point defects,<sup>[19–25]</sup> nanoprecipitates,<sup>[26–30]</sup> etc. However, thermoelectric power generation demands not only high *ZT* but also high PF over a wide range of temperature, which directly determines output power density  $\omega$ , another crucial parameter for power generation.<sup>[31–33]</sup> Frustratingly, due to the intrinsic conflicts of the parameters, simultaneous optimization of electric and thermal properties is extremely difficult. Most of approaches to increase the phonon scattering also cause carrier scattering, resulting in reduced carrier mobility and decreased PF. Therefore, suppressing lattice thermal conductivity without affecting the carrier mobility and PF becomes a prime issue for realizing high power thermoelectric generators.<sup>[6,34,35]</sup>

Among the various high-performance thermoelectric materials, half-Heusler (HH) compounds, with a formula ABZ, where A can be an early transition metal or a rare-earth element, B is a less electropositive transition metal, and Z is a main group element, are identified as promising materials for power generation due to their intrinsically high PF<sup>[36–40]</sup> and good thermomechanical stability.<sup>[41]</sup> But the large lattice thermal conductivity originating from their simple crystal structure and strong bonding impairs high *ZT* achievement,<sup>[42]</sup> hence nanostructuring and isoelectronic alloying were employed for reducing the lattice thermal conductivity, but also detrimental to the carrier mobility. For instance, although strong phonon scattering contributes to p-type ZrCoSb achieving benchmark *ZT* of  $\approx$ 1 at 1100 K, the mobility is usually less than 10 cm<sup>2</sup> V<sup>-1</sup> s<sup>-1</sup> at







Figure 1. Comparison of temperature-dependent PF among  $Nb_{0.95}M_{0.05}FeSb~(M=Hf,~Zr,~Ti)$  and other high-performance thermoelectric materials.  $^{[10,12,29,33,35,56-59]}$ 

300 K, thus the peak PF is only around 30  $\mu$ W cm<sup>-1</sup> K<sup>-2</sup>.<sup>[21,43,44]</sup> It is worthwhile to note that ZrNiSn-based n-type HH compounds possess a relatively higher mobility (>20 cm<sup>2</sup> V<sup>-1</sup> s<sup>-1</sup> at 300 K) with a peak PF of  $\approx$ 50  $\mu$ W cm<sup>-1</sup> K<sup>-2</sup> and benchmark ZT of  $\approx 1$  at 900–1100 K.<sup>[45–49]</sup> Recently, the compound NbFeSb renewed the development of p-type HH,<sup>[13,33,50–55]</sup> such as peak PF of  $\approx 60 \,\mu\text{W}\,\text{cm}^{-1}\,\text{K}^{-2}$  at 700 K and ZT of  $\approx 1.5$  at 1200 K obtained in a heavy-band p-type NbFeSb.<sup>[51]</sup> Nevertheless, high content of dopants (e.g., 40% Ti at Nb site<sup>[50]</sup>) or isoelectronic substitutions (e.g., 40% Ta at Nb site<sup>[55]</sup>) were mainly designed to scatter phonons, causing the mobility below 20 cm<sup>2</sup> V<sup>-1</sup> s<sup>-1</sup> at 300 K, implying the possibility of achieving higher PF through improving mobility. Additionally, Rogl and co-workers investigated the phase diagram and transport properties at low temperature of the Nb-Fe-Sb system,<sup>[54]</sup> but the peak PFs are still similar with the values reported by Fu et al.<sup>[51]</sup> ( $\approx 60 \ \mu W \ cm^{-1} \ K^{-2}$ ) which is due to the nonoptimized defect scattering and strong ionized impurity scattering from the relatively high content of dopants.

In this work, we demonstrate a material system  $Nb_{0.95}M_{0.05}FeSb$  (M = Hf, Zr, Ti) with significantly enhanced PF to  $\approx 100 \ \mu\text{W} \ \text{cm}^{-1} \ \text{K}^{-2}$  at room temperature. Such a substantial enhancement is mainly ascribed to the improved carrier mobility (>20 cm<sup>2</sup> V<sup>-1</sup> s<sup>-1</sup> at 300 K). As a result, this p-type NbFeSb system possesses more competitive PF than other high-performance thermoelectric materials (e.g., lead telluride, bismuth telluride, etc.<sup>[10,12,29,35,56-59]</sup>) over a wide temperature range, as shown in Figure 1. Due to simultaneously optimize carrier mobility and suppress lattice thermal conductivity, Nb<sub>0.95</sub>Hf<sub>0.05</sub>FeSb is unique for the highest ZT of  $\approx 0.9$  at 973 K in this material system, but with the ultrahigh PF maintained. In comparison with another outstanding p-type NbFeSb  $(ZT \approx 1.5 \text{ at } 1200 \text{ K})$ ,<sup>[51]</sup> our Nb<sub>0.95</sub>Hf<sub>0.05</sub>FeSb shows a higher  $\omega$  though the  $\eta$  is a little bit lower. Furthermore, a quite large output power density  $\omega$  of  $\approx 21.6$  W cm<sup>-2</sup> is achieved based on a single-leg device under a temperature difference of ≈560 K, demonstrating the great potential of  $Nb_{0.95}Hf_{0.05}FeSb$  for power generation.

## 2. Results and Discussion

X-ray diffraction (XRD) spectra of all samples are shown in Figure S1 (Supporting Information), where the diffraction peaks correspond well with MgAgAs-type structure (space group  $F\overline{4}3m$ ), indicating pure HH phase for all samples. Figure 2 shows the scanning electron microscope (SEM) images of Nb095Hf005FeSb and Nb095Zr005FeSb with hot pressing (HP) temperatures of 1173, 1273, and 1323 K, where the increased grain size from hundreds of nanometers to a few micrometers with HP temperature was clearly observed. In addition, lack of pores within the large areas indicates the uniformity of samples with high density (Figure S2, Supporting Information), which was further confirmed by the relative density of >98% presented in Table S1 (Supporting Information). The uniform element distribution in samples hot pressed at higher and lower temperature was observed, as shown in Figures S3 and S4 (Supporting Information).

**Figure 3** shows the temperature-dependent electrical properties of  $Nb_{0.95}Hf_{0.05}FeSb$  and  $Nb_{0.95}Zr_{0.05}FeSb$ . In Figure 3a, the *S* curves are almost overlapped showing weak dependence on either HP temperature or doping element, which is mainly due to their similar doping concentrations and band structures. The estimated *S* based on the single parabolic band (SPB) model (shown by the dashed line) corresponds well with the experimental data. Here, the SPB model is described as

$$S = + \frac{k_{\rm B}}{e} \left[ \frac{2F_1(\eta_{\rm F})}{F_0(\eta_{\rm F})} - \eta_{\rm F} \right]$$
(1)

$$F_n(\eta_F) = \int_0^\infty \frac{\chi^n}{1 + \exp(\chi - \eta_F)} \,\mathrm{d}\chi \tag{2}$$

where  $k_{\rm B}$  is the Boltzmann constant,  $\eta_{\rm F}$  is the reduced Fermi energy ( $\eta_{\rm F} = E_{\rm F}/k_{\rm B}$ T), and  $F_n(\eta_{\rm F})$  is the Fermi integral of order *n*. As shown in Figure 3b, the  $\sigma$  decreases monotonically with temperature, which is the typical behavior of any degenerate or metal-like semiconductor. Note that in contrast to the S barely affected by the HP temperature, a noticeable difference in the  $\sigma$  as function of the HP temperature was observed. For the samples hot pressed at higher temperatures (1273 and 1323 K), the behavior of  $\sigma$  follows the T<sup>-1.5</sup> law, suggesting acoustic-phonon-dominated carrier scattering. While, the  $\sigma$  of Hf- and Zr-doped samples hot pressed at 1173 K exhibit T<sup>-0.67</sup> and  $T^{-0.58}$  dependence at lower temperature range, respectively, which implies the mixed scattering mechanism being dominant.<sup>[60,61]</sup> Basically, due to both Hf and Zr are quite efficient dopants to supply carriers, the similar  $n_{\rm H}$  was achieved (see Table S1 in the Supporting Information). Hence, the disparity in  $\sigma$  originated from the varying  $\mu_{\rm H}$ , which is very sensitive to the scattering mechanism.<sup>[60-62]</sup> Figure 3c shows a significant  $\mu_{\rm H}$  improvement in the samples hot pressed at higher temperatures regardless of doping element, for instance, the  $\mu_{\rm H}$  of Hf-doped sample hot pressed at 1323 K shows  $\approx$ 75%





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**Figure 2.** SEM images of a–c)  $Nb_{0.95}Hf_{0.05}FeSb$  and d–f)  $Nb_{0.95}Zr_{0.05}FeSb$  hot pressed at 1323, 1273, and 1173 K, respectively. The insets of (c) and (f) correspond to the samples hot pressed at 1173 K with high magnification for easier recognition of the grain size.

higher than that at 1173 K. Such a substantial improvement benefits from the special nature of NbFeSb with rapid diffusion and grain growth at high temperatures, resulting in less grain boundaries and probably few point defects. This was also confirmed by the different temperature exponents for the  $\sigma$ -*T* curves. Owing to the similar *S* and improved  $\mu_{\rm H}$ , the PF is significantly enhanced via hot pressing at higher temperature, as shown in Figure 3d, where the peak PF of Hf-doped



**Figure 3.** Temperature-dependent electrical properties of Nb<sub>0.95</sub>Hf<sub>0.05</sub>FeSb and Nb<sub>0.95</sub>Zr<sub>0.05</sub>FeSb hot pressed at 1323, 1273, and 1173 K. a) Seebeck coefficient, b) electrical conductivity, c) Hall mobility at 300 K, together with the data of Ti doping,<sup>[33]</sup> and d) power factor.



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**Figure 4.** Temperature-dependent a) total thermal conductivity, b) lattice thermal conductivity, and c) figure of merit ZT for Nb<sub>0.95</sub>Hf<sub>0.05</sub>FeSb and Nb<sub>0.95</sub>Zr<sub>0.05</sub>FeSb hot pressed at 1323, 1273, and 1173 K. d) Comparison of temperature-dependent ZT among Nb<sub>0.95</sub>M<sub>0.05</sub>FeSb, together with the data of Ti doping.<sup>[33]</sup>

sample hot pressed at 1323 K is  $\approx 103 \ \mu\text{W} \ \text{cm}^{-1} \ \text{K}^{-2}$  at 308 K and that of Zr-doped sample is  $\approx 97 \ \mu W \ cm^{-1} \ K^{-2}$ . In addition to the ultrahigh peak value,  $Nb_{0.95}M_{0.05}FeSb$  (M = Hf, Zr, Ti) system also showed remarkable enhancement in PF over a wide range of temperature in comparison with other highperformance thermoelectric materials (see Figure 1), indicating the great potential for power generation over a wide temperature range. Furthermore, understanding the carrier scattering mechanism plays a crucial role in optimizing the electrical properties of thermoelectric materials, such as Mao et al. demonstrated a significant enhancement in the mobility and PF of n-type Mg<sub>3.2</sub>Sb<sub>1.5</sub>Bi<sub>0.49</sub>Te<sub>0.01</sub> by carefully tuning the hot pressing temperature to manipulate the variation of scattering mechanisms,<sup>[61]</sup> while few studies focusing on the scattering mechanism in HH.<sup>[63,64]</sup> Therefore, further systematical investigation on the carrier scattering mechanism in the materials with ultrahigh PF is still necessary.

**Figure 4**a shows the temperature-dependent total thermal conductivity  $\kappa$  of Nb<sub>0.95</sub>Hf<sub>0.05</sub>FeSb and Nb<sub>0.95</sub>Zr<sub>0.05</sub>FeSb hot pressed at 1173, 1273, and 1323 K, which is dependent on either doping element or HP temperature. As known,  $\kappa$  includes the contributions of lattice  $\kappa_{\rm L}$  and electronic  $\kappa_{\rm e}$ , where  $\kappa_{\rm e} = L\sigma T$  (*L* is the Lorenz number estimated by the SPB model),

$$L = \left(\frac{k_{\rm B}}{e}\right)^2 \left[\frac{3F_2(\eta_{\rm F})}{F_0(\eta_{\rm F})} - \left(\frac{2F_1(\eta_{\rm F})}{F_0(\eta_{\rm F})}\right)^2\right]$$
(3)

The lower  $\kappa$  for the samples hot pressed at lower temperature is due to the reduced  $\sigma$ . By subtracting the  $\kappa_e$  from  $\kappa$ , the  $\kappa_{\rm L}$  are presented in Figure 4b, which is slightly affected by HP temperature, suggesting little influence of the grain boundary scattering on the phonon transport. This experimental observation is consistent with our previous studies on Nb<sub>0.95</sub>Ti<sub>0.05</sub>FeSb, which is due to the dominant phonon mean free paths within the range of a few tens to a few hundreds of nanometers that are smaller than the grain size.<sup>[33]</sup> However, the relatively large  $\kappa_{\rm L}$  of Zr- and Ti-doped samples almost offset the improvement of PF, but the Hf-doped samples are noticeable for the significantly suppressed  $\kappa_{I}$ . As Glassbrenner and Slack suggested,  $\kappa_{\rm L}$  follows  $T^{-1}$  law if only considering Umklapp phonon scattering process at temperature higher than the Debye temperature.<sup>[65]</sup> Note that the  $\kappa_{\rm L}$  of all samples shows  $T^{-k}$  dependence with the exponent k of  $\approx 0.8$  for Zr doping and  $\approx 0.6$  for Hf doping, respectively. The reduced exponent k in Hf-doped samples implies a strong point defect phonon scattering.<sup>[19,20]</sup> Hence the  $\kappa_{\rm L}$  of Hf-doped samples is significantly suppressed owing to the strong mass fluctuation and surrounding strain field fluctuation between Nb and Hf atoms (see details in the Supporting Information). Regardless of doping element, owing to improved PF and almost unchanged  $\kappa_{\rm L}$  at higher HP temperature, ZT increased by simply increasing HP temperature, as shown in Figure 4c. More importantly, among the materials  $Nb_{0.95}M_{0.05}FeSb$  (M = Hf, Zr, Ti) with ultrahigh PF, Nb<sub>0.95</sub>Hf<sub>0.05</sub>FeSb hot pressed at 1323 K distinguishes itself



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**Figure 5.** Comparison of a) average PF and average ZT, b) engineering PF and ZT, c) output power density, and d) efficiency between  $Nb_{0.95}Hf_{0.05}FeSb$  and other outstanding NbFeSb-based materials.<sup>[33,51]</sup>

for simultaneous optimization of PF and suppression of  $\kappa_L$ , leading to a peak *ZT* of  $\approx$ 0.9 at 973 K, which is 22% and 37% higher than those of Ti- and Zr-doped samples shown in Figure 4d.

As aforementioned, both the output power density  $\omega$  and conversion efficiency  $\eta$  are crucial to power generation. In literature, average values ( $PF_{avg}$  and  $ZT_{avg}$ ) were used to calculate the  $\omega$  and  $\eta$ , but they are not as reliable as the engineering values (PF<sub>eng</sub> and ZT<sub>eng</sub>).<sup>[8]</sup> Figure 5a,b shows the detailed comparison of average values and engineering values, respectively, among Nb<sub>0.95</sub>Hf<sub>0.05</sub>FeSb (hot pressed at 1323 K) and other outstanding p-type NbFeSb, e.g.,  $\mathrm{Nb}_{0.95}\mathrm{Ti}_{0.05}\mathrm{FeSb}$  with high PF over a wide range of temperature<sup>[33]</sup> and Nb<sub>0.86</sub>Hf<sub>0.14</sub>FeSb with peak ZT of  $\approx 1.5$  at 1200 K.<sup>[51]</sup> It is shown that Nb<sub>0.95</sub>Hf<sub>0.05</sub>FeSb has basically the same  $T_{\rm H}$ -dependence ( $T_{\rm H}$  and  $T_{\rm C}$  are hot-side and cold-side temperature, respectively) of  $\text{PF}_{\text{avg}}$  and  $\text{PF}_{\text{eng}},$ but higher  $ZT_{avg}$  and  $ZT_{eng}$  over the whole temperature range compared with high-PF material  $Nb_{0.95} Ti_{0.05} FeSb.$  For the high-ZT material Nb<sub>0.86</sub>Hf<sub>0.14</sub>FeSb being concerned, it is very clear that both  $\text{PF}_{\text{avg}}$  and  $\text{PF}_{\text{eng}}$  of  $\text{Nb}_{0.95}\text{Hf}_{0.05}\text{FeSb}$  are much higher within the overall temperature range even though the  $ZT_{avg}$  and  $ZT_{eng}$  of Nb<sub>0.86</sub>Hf<sub>0.14</sub>FeSb are higher at above 700 K. By further investigation of thermoelectric performance among these p-type HH compounds, the calculated  $\omega$  based on PF<sub>ave</sub> and  $PF_{eng}$  are shown in Figure 5c and  $\eta$  based on  $ZT_{avg}$  and  $ZT_{eng}$  shown in Figure 5d ( $T_{C}$  and  $T_{H}$  are 298 and 973 K, respectively). To demonstrate the adequacy of the calculated

values, numerical simulations of  $\omega$  and  $\eta$  based on the finite difference method are also presented (both the calculated  $\omega$  and  $\eta$  based on engineering values have a smaller margin of error). Noticeably, compared with Nb<sub>0.95</sub>Ti<sub>0.05</sub>FeSb,<sup>[33]</sup> the  $\eta$  of Nb<sub>0.95</sub>Hf<sub>0.05</sub>FeSb shows 11% enhancement, while the  $\omega$  are almost the same. By comparison with Nb<sub>0.86</sub>Hf<sub>0.14</sub>FeSb,<sup>[51]</sup> Nb<sub>0.95</sub>Hf<sub>0.05</sub>FeSb has a 14% higher in  $\omega$  though  $\eta$  is 9.8% lower, which is very significant in the specific applications (e.g., unlimited heat supply or heat sink) where  $\omega$  is more important.<sup>[31]</sup> Thus, our Nb<sub>0.95</sub>Hf<sub>0.05</sub>FeSb is more suitable for power generation in case of high  $\omega$  is required but also with decent  $\eta$ .

To corroborate the ultrahigh PF of Nb<sub>0.95</sub>Hf<sub>0.05</sub>FeSb, a single-leg device was performed for output power density measurement in a homemade system<sup>[66]</sup> (details are available in the Supporting Information). **Figure 6**a shows the obtained voltage (*V*) and power (*P*) as a function of the applied electric current (*I*) at the *T*<sub>C</sub> of ≈313 K and *T*<sub>H</sub> of ≈873 K. Figure 6b shows the *T*<sub>H</sub>-dependent maximum output power density ( $\omega_{max}$ ) and the inset shows the experimental setup of the single-leg device. Note that when *T*<sub>H</sub> is above 773 K, the measured result deviates more from the simulation value, which was mainly due to the rise of *T*<sub>C</sub> (the simulation assumes a fixed *T*<sub>C</sub> of 298 K). In spite of that, a large  $\omega_{max}$  of ≈21.6 W cm<sup>-2</sup> was obtained at the *T*<sub>C</sub> of ≈313 K and *T*<sub>H</sub> of ≈873 K, demonstrating the excellent performance of Nb<sub>0.95</sub>Hf<sub>0.05</sub>FeSb in power generation.



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**Figure 6.** Measurement of output power density of Nb<sub>0.95</sub>Hf<sub>0.05</sub>FeSb. a) The measured voltage and power with varying applied electric current at  $T_{\rm C}$  of  $\approx$ 313 K and  $T_{\rm H}$  of  $\approx$ 873 K. b)  $T_{\rm H}$ -dependent maximum output power density (normalized to the length of 2 mm), and the inset shows the experimental setup of the single-leg device.

### 3. Conclusion

In summary, by simultaneous optimization of carrier mobility and suppression of lattice thermal conductivity, a peak *ZT* of ~0.9 at 973 K with ultrahigh PF over 100  $\mu$ W cm<sup>-1</sup> K<sup>-2</sup> at room temperature was achieved in Nb<sub>0.95</sub>Hf<sub>0.05</sub>FeSb. In addition to peak values of *ZT* and PF, detailed studies of average values and engineering values demonstrate unique performance of Nb<sub>0.95</sub>Hf<sub>0.05</sub>FeSb for power generation in comparison with other outstanding NbFeSb-based materials. As expected, a large output power density of ~21.6 W cm<sup>-2</sup> was achieved based on a single-leg device of Nb<sub>0.95</sub>Hf<sub>0.05</sub>FeSb under a temperature difference of ~560 K, showing the great potential for realizing high power thermoelectric generators.

## 4. Experimental Section

Synthesis: The samples with nominal compositions of Nb<sub>0.95</sub>Hf<sub>0.05</sub>FeSb and Nb<sub>0.95</sub>Zr<sub>0.05</sub>FeSb were prepared by arc melting, ball milling, and hot pressing process. The stoichiometrically weighed raw materials (Nb foils, 99.95%; Fe granules, 99.98%; Sb shots, 99.8%; Hf sponges, 99.9%; Zr sponges, 99.2%) were melted for several times in an Ar-protected chamber to form homogeneous ingots. Subsequently, the ingots were loaded into the Ar-filled stainless steel jar and ball milled for 3 h. The ball-milled powders were finally consolidated into disks with diameter of  $\approx$ 12.7 mm via direct-current assisted hot pressing process. The hot pressing temperatures for each composition were at 1173, 1273, and 1323 K with holding for 2 min.

*Structure Characterization*: The phases of samples were characterized by an XRD instrument (PANalytical X'Pert Pro). Scanning electron microscope (LEO 1525) was applied to reveal the morphology of samples. The elemental mapping was performed by energy-dispersive X-ray spectroscopy (JEOL 6340F).

Thermoelectric Measurement: Thermal conductivity were calculated according to  $\kappa = DC_P\rho$ , where D is the thermal diffusivity measured in a laser flash instrument (LFA457, Netzsch),  $C_P$  is the specific heat measured in a differential scanning calorimeter apparatus (DSC 404 C, Netzsch), and  $\rho$  is the mass density obtained by Archimedes method. Bar-shaped samples cut from the disks, were performed for simultaneous measurement of Seebeck coefficient and electrical conductivity in a ZEM-3 system (ULVAC). Carrier concentration ( $n_H$ ) at room temperature was measured in a physical properties measurement system (Quantum Design) and Hall mobility ( $\mu_H$ ) were calculated based on  $\sigma = n_H e \mu_H$ , where e is the electronic charge. As shown in Table S1 (Supporting Information), the  $n_H$  results were quite close to the theoretical expectation by assuming one carrier from one doping atom

(~9.5  $\times$   $10^{20}~{\rm cm}^{-3}),$  indicating that both Hf and Zr were very effective p-type dopants in NbFeSb.

# Supporting Information

Supporting Information is available from the Wiley Online Library or from the author.

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# **Conflict of Interest**

The authors declare no conflict of interest.

## Keywords

half-Heusler compounds, power generation, simultaneous optimization, thermoelectric materials

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